

## CMOS Quad AND/OR Select Gate

High-Voltage Types (20-Volt Rating)

■ CD4019B types consist of four AND/OR select gate configurations, each consisting of two 2-input AND gates driving a single 2-input OR gate. Selection is accomplished by control bits  $K_A$  and  $K_B$ . In addition to selection of either channel A or channel B information, the control bits can be applied simultaneously to accomplish the logical  $A + B$  function.

The CD4019B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

### MAXIMUM RATINGS, Absolute-Maximum Values:

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD}$  +0.5V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10$ mA

#### POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A = -55^\circ\text{C}$  to  $+100^\circ\text{C}$  ..... 500mW

For  $T_A = +100^\circ\text{C}$  to  $+125^\circ\text{C}$  ..... Derate Linearly at 12mW/ $^\circ\text{C}$  to 200mW

#### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$  ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) .....  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE ( $T_{stg}$ ) .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$

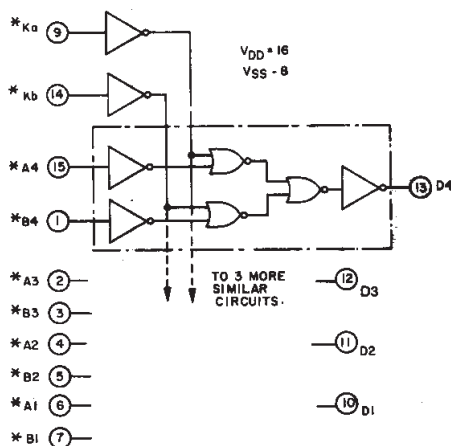
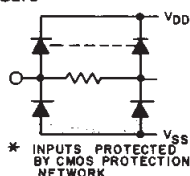
#### LEAD TEMPERATURE (DURING SOLDERING):

At distance  $1/16 \pm 1/32$  inch ( $1.59 \pm 0.79$ mm) from case for 10s max .....  $+265^\circ\text{C}$

### TRUTH TABLE

| $K_A$ | $K_B$ | $A_n$ | $B_n$ | $D_n$ |
|-------|-------|-------|-------|-------|
| 1     | 0     | 1     | X     | 1     |
| 1     | 0     | 0     | X     | 0     |
| 0     | 1     | X     | 1     | 1     |
| 0     | 1     | X     | 0     | 0     |
| 0     | 0     | X     | X     | 0     |
| 1     | 1     | 0     | 0     | 0     |
| 1     | 1     | 0     | 1     | 1     |
| 1     | 1     | 1     | 0     | 1     |
| 1     | 1     | 1     | 1     | 1     |

X = Don't Care



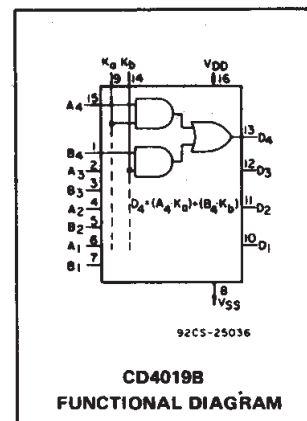
92CS-35272

Fig. 1—Logic diagram.

# CD4019B Types

### Features:

- Medium-speed operation . . . . .  
...  $t_{PHL} = t_{PLH} = 60$  ns (typ.) at  $C_L = 50$  pF,  $V_{DD} = 10$  V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Maximum input current of 1  $\mu$ A at 18 V over full package-temperature range; 100 nA at 18 V and  $25^\circ\text{C}$
- Noise margin (full package-temperature range) =  
1 V at  $V_{DD} = 5$  V  
2 V at  $V_{DD} = 10$  V  
2.5 V at  $V_{DD} = 15$  V



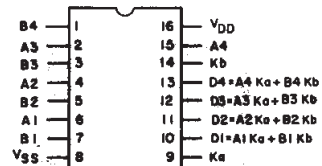
CD4019B  
FUNCTIONAL DIAGRAM

### Applications:

- AND-OR select gating
- Shift-right/shift-left registers
- True/complement selection
- AND/OR/Exclusive-OR selection

### TERMINAL DIAGRAM

#### Top View



92CS-24461

### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                                                               | $V_{DD}$<br>(V) | Min. | Max. | Units |
|------------------------------------------------------------------------------|-----------------|------|------|-------|
| Supply-Voltage Range<br>(For $T_A = \text{Full Package Temperature Range}$ ) | -               | 3    | 18   | V     |

# CD4019B Types

## STATIC ELECTRICAL CHARACTERISTICS

| CHARAC-<br>TERISTIC                                         | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | U<br>N<br>I<br>T<br>S |
|-------------------------------------------------------------|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-----------------------|
|                                                             | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) | -55                                   | -40   | +85   | +125  | +25   |                   |      |                       |
|                                                             |                       |                        |                        |                                       |       |       |       | Min.  | Typ.              | Max. |                       |
| Quiescent<br>Device<br>Current, I <sub>DD</sub><br>Max.     | —                     | 0,5                    | 5                      | 1                                     | 1     | 30    | 30    | —     | 0.02              | 1    | μA                    |
|                                                             | —                     | 0,10                   | 10                     | 2                                     | 2     | 60    | 60    | —     | 0.02              | 2    |                       |
|                                                             | —                     | 0,15                   | 15                     | 4                                     | 4     | 120   | 120   | —     | 0.02              | 4    |                       |
|                                                             | —                     | 0,20                   | 20                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |                       |
| Output Low<br>(Sink)<br>Current<br>I <sub>OL</sub> Min.     | 0.4                   | 0,5                    | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA                    |
|                                                             | 0.5                   | 0,10                   | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |                       |
|                                                             | 1.5                   | 0,15                   | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |                       |
| Output High<br>(Source)<br>Current,<br>I <sub>OH</sub> Min. | 4.6                   | 0,5                    | 5                      | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | —    | mA                    |
|                                                             | 2.5                   | 0,5                    | 5                      | -2                                    | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | —    |                       |
|                                                             | 9.5                   | 0,10                   | 10                     | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | —    |                       |
|                                                             | 13.5                  | 0,15                   | 15                     | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | —    |                       |
| Output Voltage:<br>Low-Level,<br>V <sub>OL</sub> Max.       | —                     | 0,5                    | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V                     |
|                                                             | —                     | 0,10                   | 10                     | 0.05                                  |       |       |       | —     | —                 | 0.05 |                       |
|                                                             | —                     | 0,15                   | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |                       |
| Output Voltage:<br>High-Level,<br>V <sub>OH</sub> Min.      | —                     | 0,5                    | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    | V                     |
|                                                             | —                     | 0,10                   | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |                       |
|                                                             | —                     | 0,15                   | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |                       |
| Input Low<br>Voltage,<br>V <sub>IL</sub> Max.               | 0.5,4.5               | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  | V                     |
|                                                             | 1,9                   | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |                       |
|                                                             | 1.5,13.5              | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |                       |
| Input High<br>Voltage,<br>V <sub>IH</sub> Min.              | 0.5,4.5               | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    | V                     |
|                                                             | 1,9                   | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |                       |
|                                                             | 1.5,13.5              | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |                       |
| Input Current<br>I <sub>IN</sub> Max.                       | —                     | 0,18                   | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>-5</sup> | ±0.1 | μA                    |

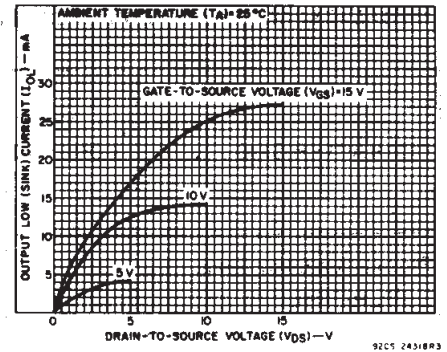


Fig. 2 - Typical output low (sink) current characteristics.

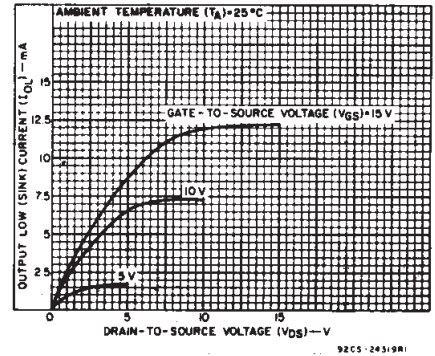


Fig. 3 - Minimum output low (sink) current characteristics.

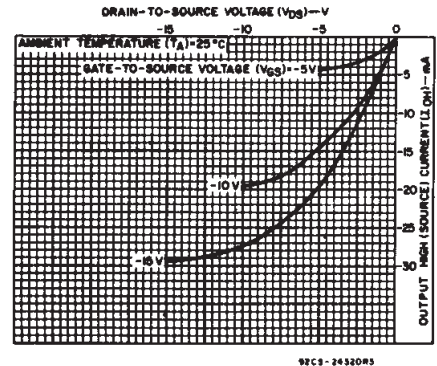


Fig. 4 - Typical output high (source) current characteristics.

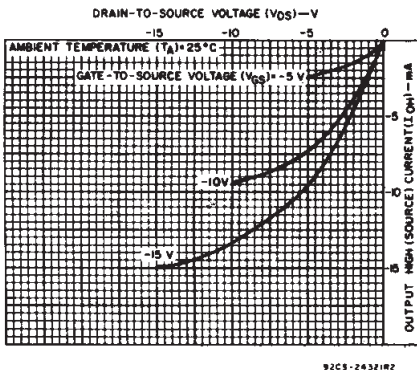


Fig. 5 - Minimum output high (source) current characteristics.

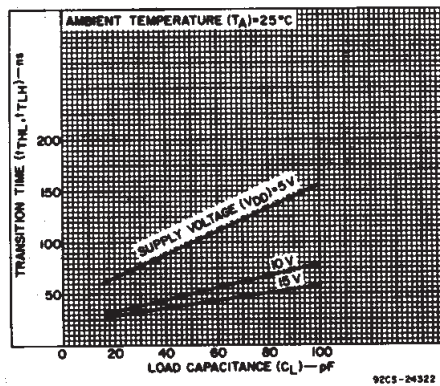


Fig. 6 - Typical transition time as a function of load capacitance.

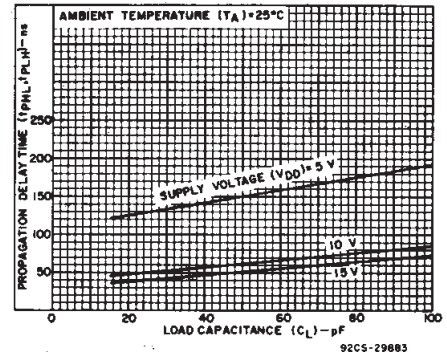


Fig. 7 - Propagation delay time as a function of load capacitance.

## CD4019B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ , Input  $t_r, t_f = 20\text{ ns}$ ,  $C_L = 50\text{ pF}$ ,  $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC                                | TEST CONDITIONS        | VDD (V) | LIMITS |      |      | UNITS |
|-----------------------------------------------|------------------------|---------|--------|------|------|-------|
|                                               |                        |         | Min.   | Typ. | Max. |       |
| Propagation Delay Time;<br>$t_{PLH}, t_{PHL}$ |                        | 5       | —      | 150  | 300  | ns    |
|                                               |                        | 10      | —      | 60   | 120  |       |
|                                               |                        | 15      | —      | 50   | 100  |       |
| Transition Time;<br>$t_{THL}, t_{TLH}$        |                        | 5       | —      | 100  | 200  | ns    |
|                                               |                        | 10      | —      | 50   | 100  |       |
|                                               |                        | 15      | —      | 40   | 80   |       |
| Input Capacitance, $C_{IN}$                   | All A and B Inputs     |         | —      | 5    | 7.5  | pF    |
|                                               | $K_a$ and $K_b$ Inputs |         | —      | 10   | 15   | pF    |

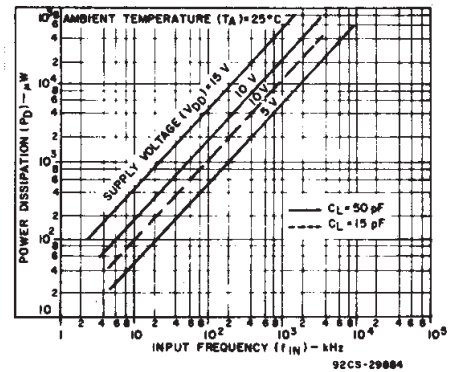


Fig. 8 — Typical dynamic power dissipation as a function of input frequency.

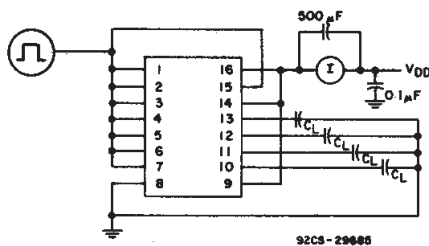


Fig. 9 — Dynamic power dissipation test circuit.

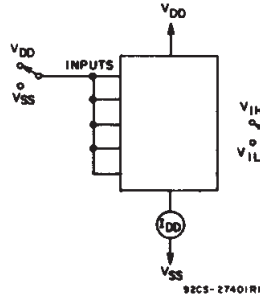


Fig. 10 — Quiescent device current test circuit.

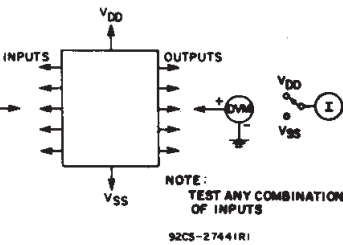


Fig. 11 — Input voltage test circuit.

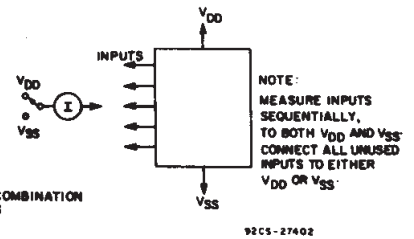


Fig. 12 — Input current test circuit.

## TYPICAL APPLICATIONS

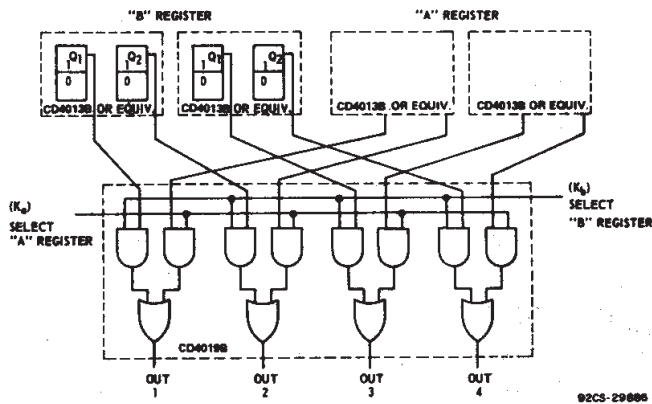


Fig. 13 — AND/OR select gating.

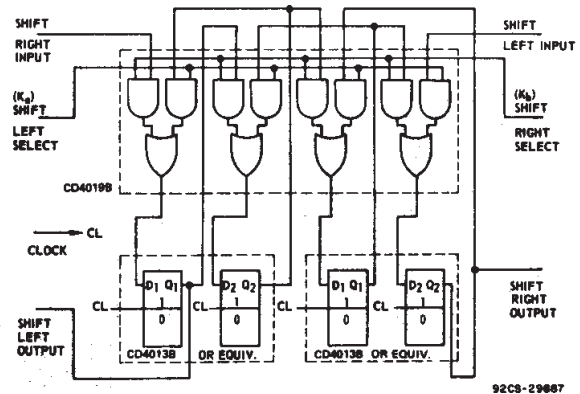


Fig. 14 — "Shift left/shift right" register.

# CD4019B Types

## TYPICAL APPLICATIONS (CONT'D)

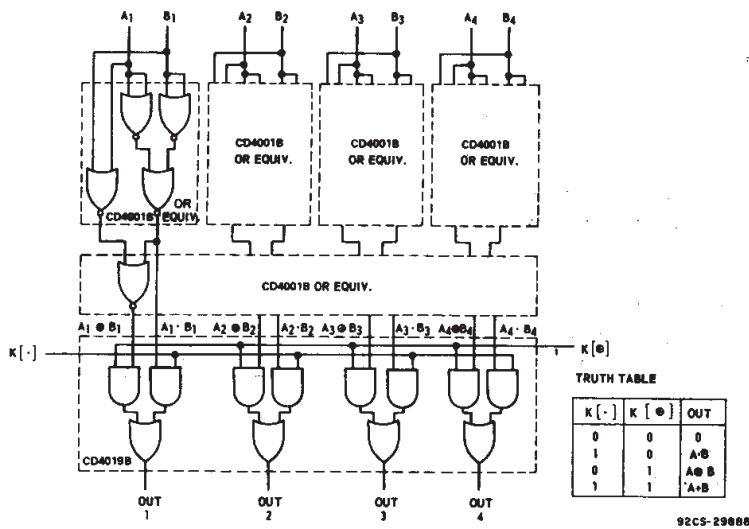


Fig. 15 — AND/OR Exclusive-OR selector.

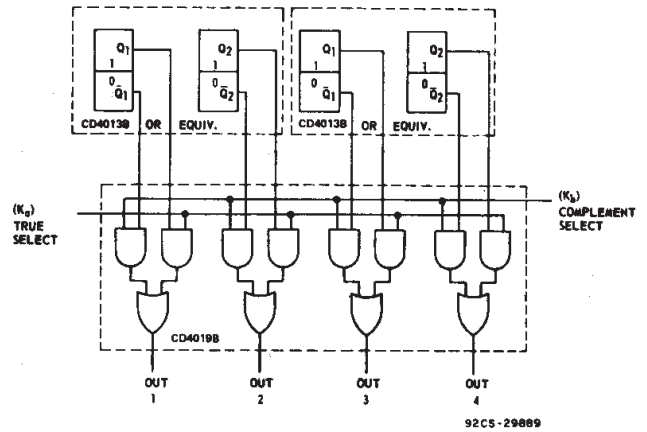
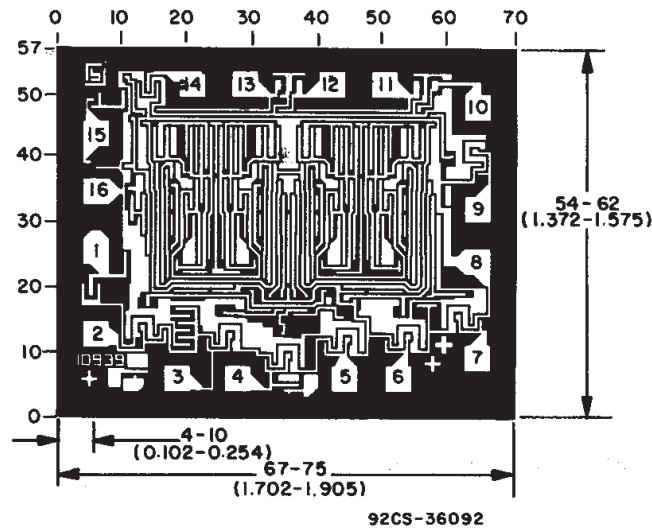


Fig. 16 — "True complement" selector.



Dimensions and pad layout for CD4019BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).

## PACKAGING INFORMATION

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)  |
|----------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|----------------------|
| <a href="#">CD4019BE</a>         | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4019BE             |
| CD4019BE.A                       | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4019BE             |
| CD4019BEE4                       | Active        | Production           | PDIP (N)   16   | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD4019BE             |
| <a href="#">CD4019BF</a>         | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4019BF             |
| CD4019BF.A                       | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4019BF             |
| <a href="#">CD4019BF3A</a>       | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4019BF3A           |
| CD4019BF3A.A                     | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD4019BF3A           |
| <a href="#">CD4019BM</a>         | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CD4019BM             |
| <a href="#">CD4019BM96</a>       | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4019BM             |
| CD4019BM96.A                     | Active        | Production           | SOIC (D)   16   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4019BM             |
| <a href="#">CD4019BMT</a>        | Obsolete      | Production           | SOIC (D)   16   | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | CD4019BM             |
| <a href="#">CD4019BNSR</a>       | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4019B              |
| CD4019BNSR.A                     | Active        | Production           | SOP (NS)   16   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CD4019B              |
| <a href="#">CD4019BPWR</a>       | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM019B               |
| CD4019BPWR.A                     | Active        | Production           | TSSOP (PW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | CM019B               |
| <a href="#">JM38510/05352BEA</a> | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05352BEA |
| JM38510/05352BEA.A               | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05352BEA |
| <a href="#">M38510/05352BEA</a>  | Active        | Production           | CDIP (J)   16   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>05352BEA |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF CD4019B, CD4019B-MIL :**

- Catalog : [CD4019B](#)
- Military : [CD4019B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

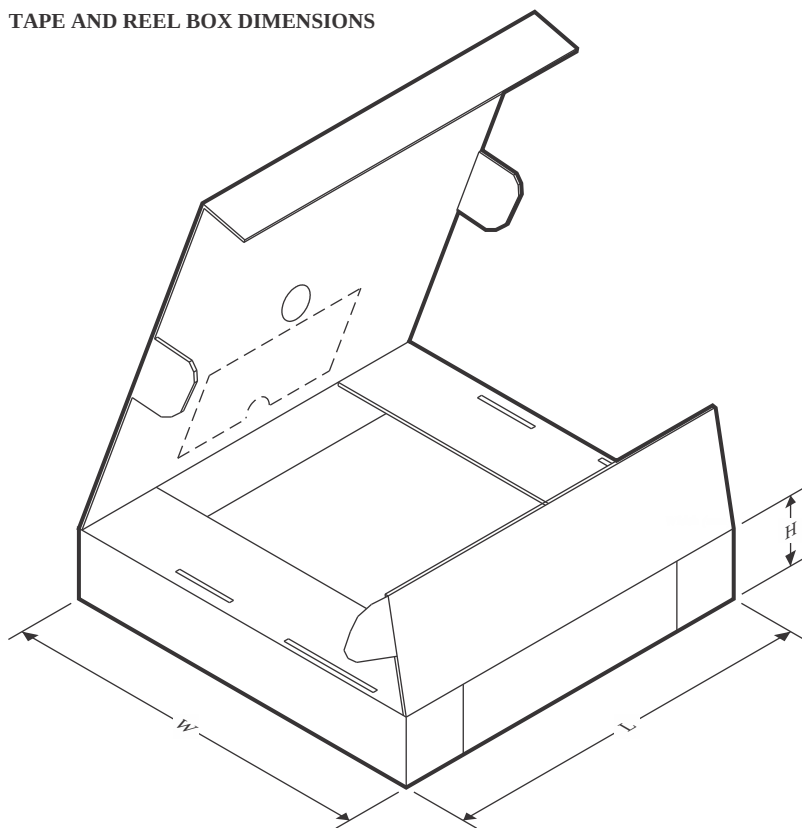
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4019BM96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4019BNSR | SOP          | NS              | 16   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4019BPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



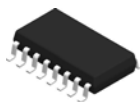
\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4019BM96 | SOIC         | D               | 16   | 2500 | 340.5       | 336.1      | 32.0        |
| CD4019BNSR | SOP          | NS              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| CD4019BPWR | TSSOP        | PW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |

**TUBE**


\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD4019BE   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4019BE   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4019BE.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4019BE.A | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4019BEE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD4019BEE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |

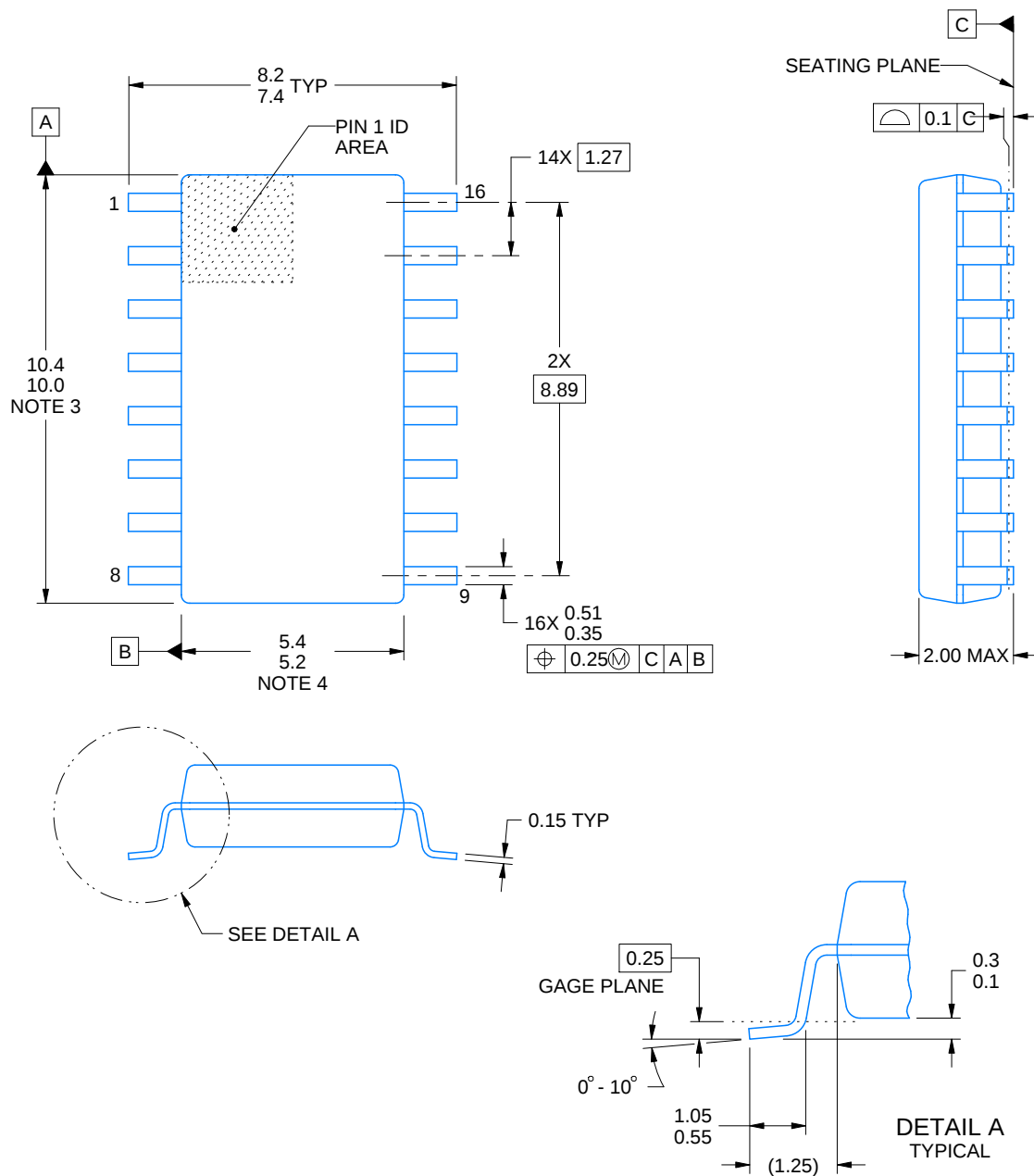


# PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

## NOTES:

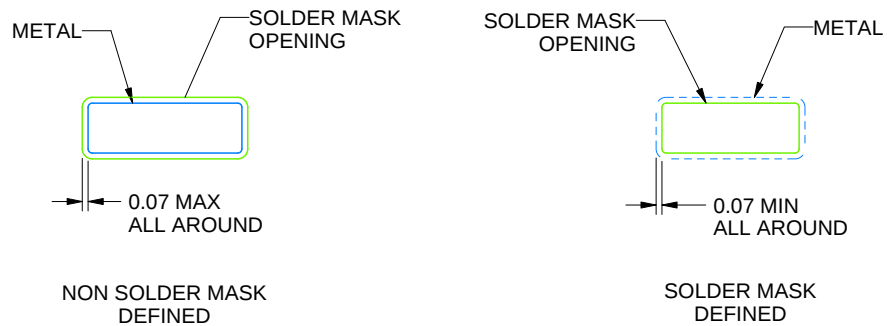
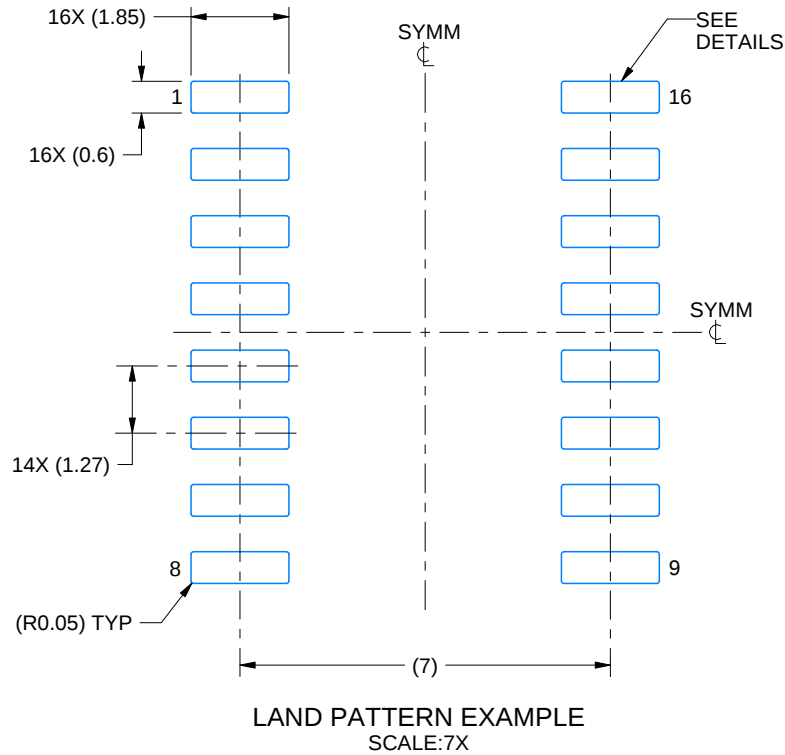
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

# EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



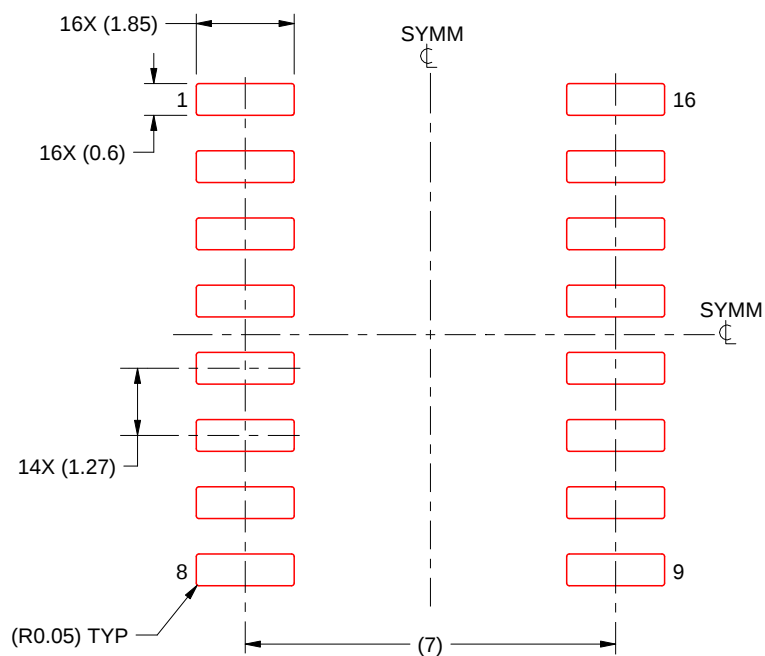
SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
 BASED ON 0.125 mm THICK STENCIL  
 SCALE:7X

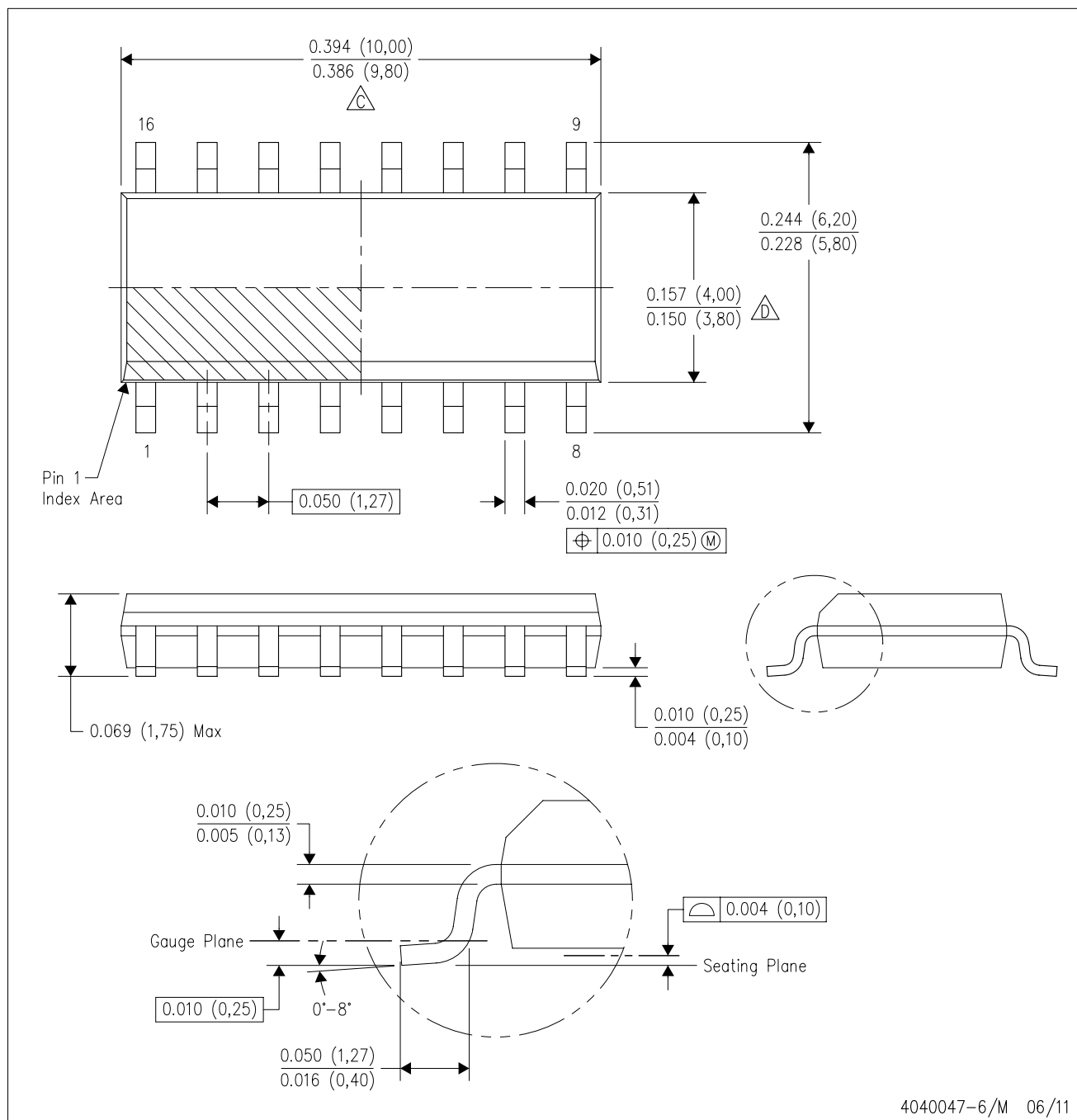
4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

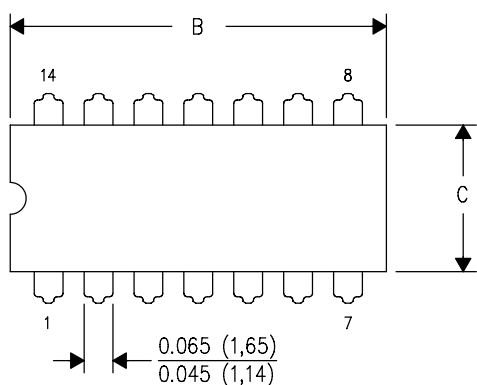


- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

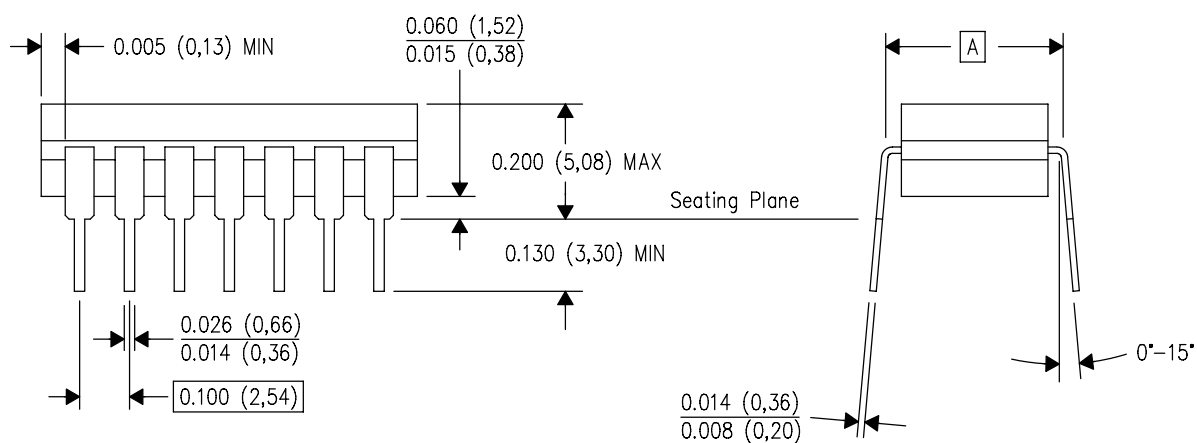
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE

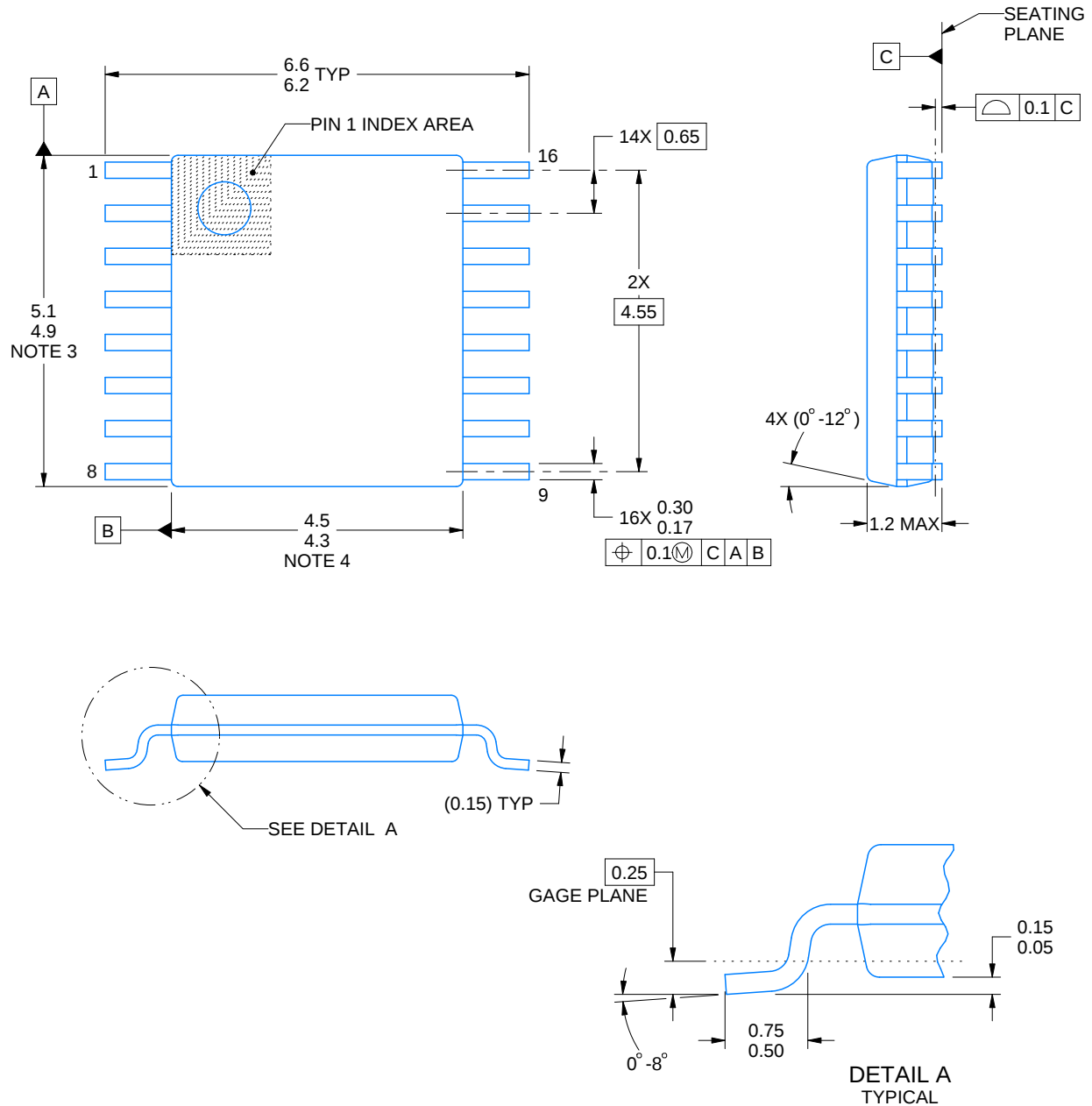
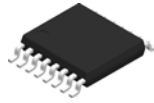


| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



4220204/B 12/2023

## NOTES:

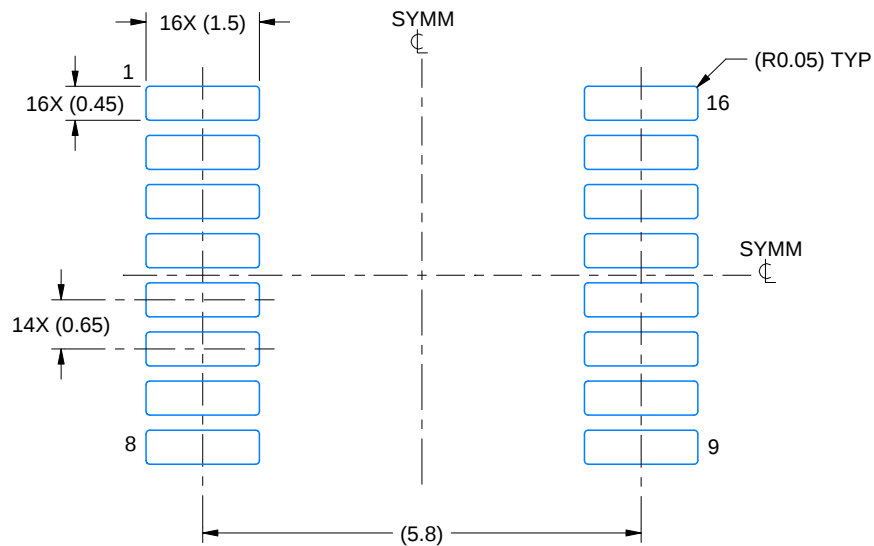
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

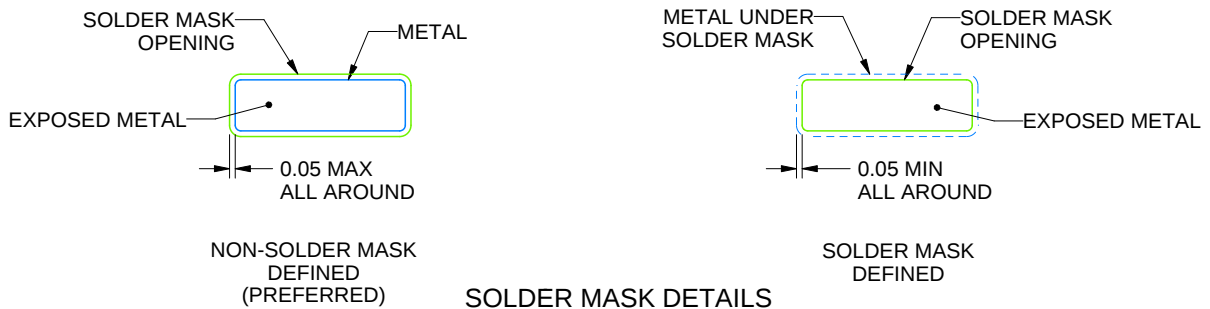
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

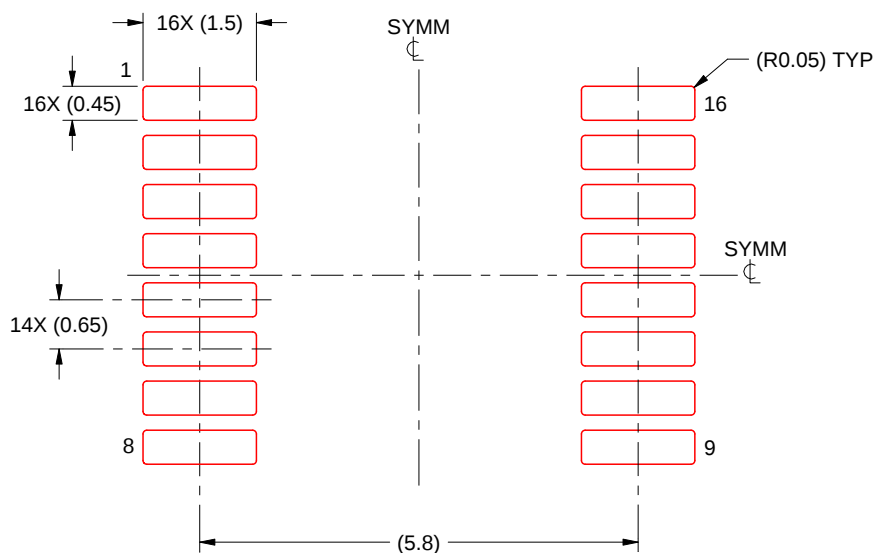
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/B 12/2023

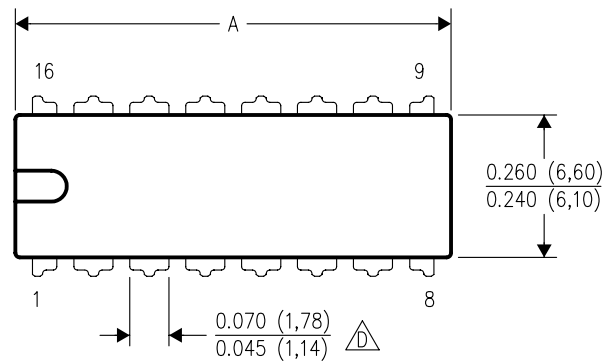
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

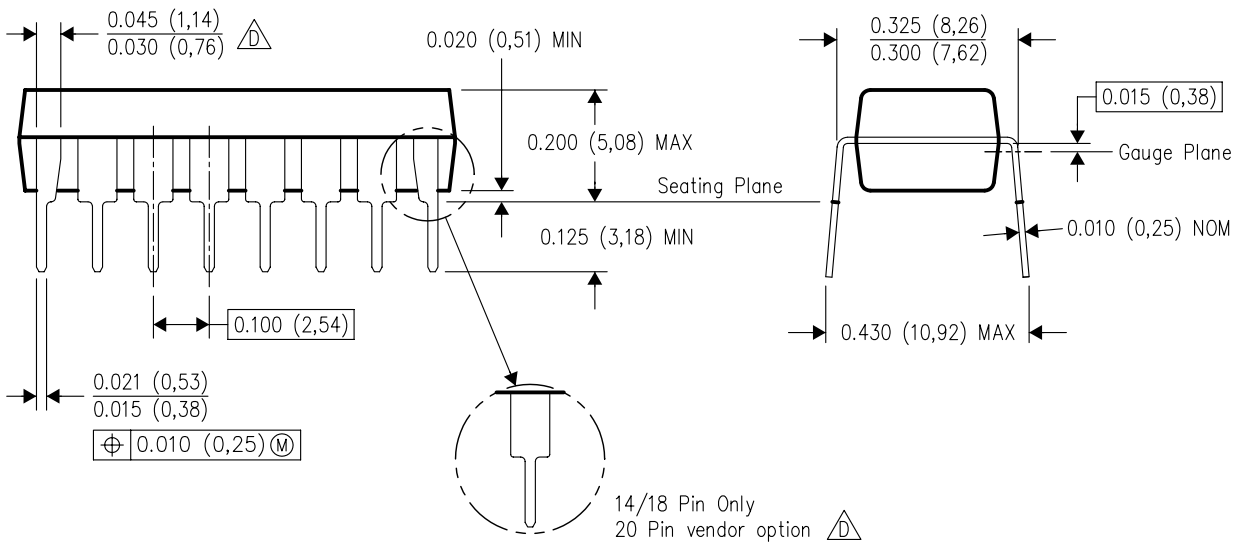
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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